

P-Channel 2.5-V (G-S) MOSFET

CHARACTERISTICS

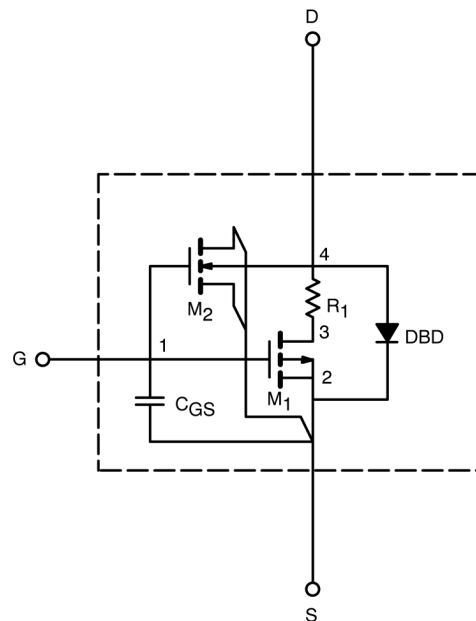
- P-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS
- Apply for both Linear and Switching Application
- Accurate over the -55 to 125°C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

DESCRIPTION

The attached spice model describes the typical electrical characteristics of the p-channel vertical DMOS. The subcircuit mode is extracted and optimized over the -55 to 125°C temperature ranges under the pulsed 0-to-5 V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{gd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

SUBCIRCUIT MODEL SCHEMATIC



This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.

SPICE Device Model Si1303DL

Vishay Siliconix



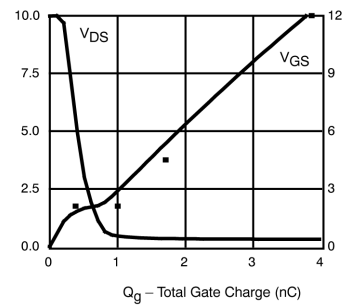
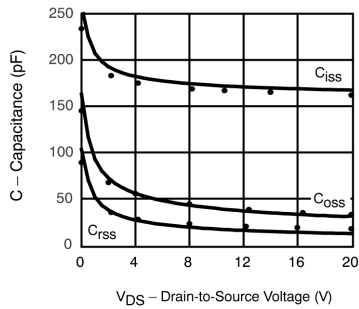
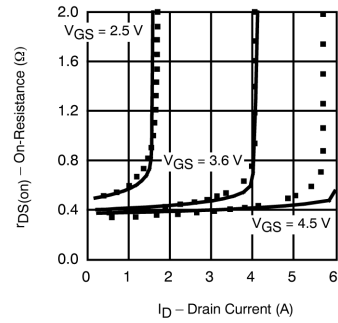
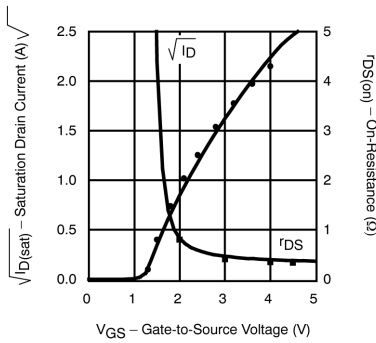
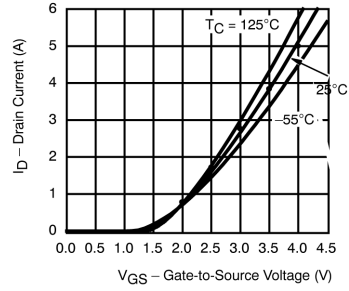
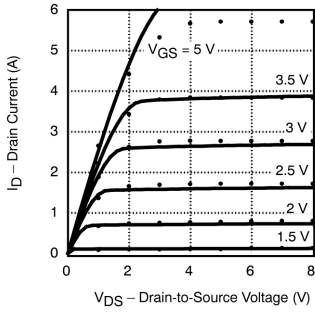
SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)					
Parameter	Symbol	Test Condition	Simulated Data	Measured Data	Unit
Static					
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	1.09		V
On-State Drain Current ^a	I _{D(on)}	V _{DS} = -5V, V _{GS} = -4.5V	6.45		A
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = -4.5V, I _D = -1A	0.38	0.36	Ω
		V _{GS} = -3.6V, I _D = -0.7A	0.41	0.40	
		V _{GS} = -2.5V, I _D = -0.3A	0.59	0.56	
Forward Transconductance ^a	g _{fs}	V _{DS} = -10V, I _D = -1A	1.7	1.7	S
Diode Forward Voltage ^a	V _{SD}	I _S = -1A, V _{GS} = 0V	0.78		V
Dynamic^b					
Total Gate Charge	Q _g	V _{DS} = -10V, V _{GS} = -4.5V, I _D = -1A	1.5	1.7	nC
Gate-Source Charge	Q _{gs}		0.38	0.38	
Gate-Drain Charge	Q _{gd}		0.63	0.63	
Turn-On Delay Time	t _{d(on)}	V _{DD} = -10V, R _L = 10Ω I _D ≅ -1A, V _{GEN} = -4.5V, R _G = 6Ω	11	9	ns
Rise Time	t _r		15	31	
Turn-Off Delay Time	t _{d(off)}		16	12.5	
Fall Time	t _f		17	14	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = -1A, di/dt = 100 A/μs	30	35	

Notes

- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
- b. Guaranteed by desing, not subject to production testing.



COMPARISON OF MODEL WITH MEASURED DATA ($T_J=25^\circ\text{C}$ UNLESS OTHERWISE NOTED)



Note: Dots and squares represent measured data.



Disclaimer

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